

## Description

The SMD0805 Series PTC provides surface mount overcurrent protection for applications where space is at a premium and resettable protection is desired.

#### **Features**

- RoHS compliant, lead-free and halogen-free
- Fast response to fault currents
- · Compact design saves board space
- Low resistance
- Low-profile
- Compatible with high temperature solders

## **Applications**

- USB peripherals
- CD-ROMs
- Disk drives

Disk drives

Mobile phones - battery and port protection

- PDAs / digital cameras
- Plug and play protection for motherboards and peripherals Game console port protection

### **Electrical Characteristics**

Type Number	I <sub>hold</sub>	l trip	V <sub>max</sub>	I max	P <sub>d</sub> max.	Maximui To T		Resis	stance
	(A)	(A)	V <sub>(dc)</sub>	(A)	(W)	Current (A)	Time (Sec.)	R <sub>min</sub> (Ω)	R <sub>1max</sub> (Ω)
SMD0805P010TF	0.10	0.30	15	100	0.5	0.50	1.50	1.000	6.000
SMD0805P020TF	0.20	0.50	9	100	0.5	8.00	0.02	0.650	3.500
SMD0805P035TF	0.35	0.75	6	100	0.5	8.00	0.10	0.250	1.200
SMD0805P050TF	0.50	1.00	6	100	0.5	8.00	0.10	0.150	0.850
SMD0805P075TF	0.75	1.500	6	40	0.6	8.00	0.20	0.090	0.350
SMD0805P100TF	1.00	1.95	6	40	0.6	8.00	0.30	0.060	0.210
SMD0805P110TF	1.10	2.00	6	100	0.8	8.00	0.10	0.050	0.160

I<sub>hold</sub> = Hold current: maximum current device will pass without tripping in 23°C still air.

I<sub>trip</sub> = Trip current: minimum current at which the device will trip in 23°C still air.

V<sub>max</sub> = Maximum voltage device can withstand without damage at rated current (I<sub>max</sub>)

 $I_{max}$  = Maximum fault current device can withstand without damage at rated voltage ( $V_{max}$ )

P<sub>d</sub> = Power dissipated from device when in the tripped state at 23°C still air.

R<sub>min</sub> = Minimum resistance of device in initial (un-soldered) state.

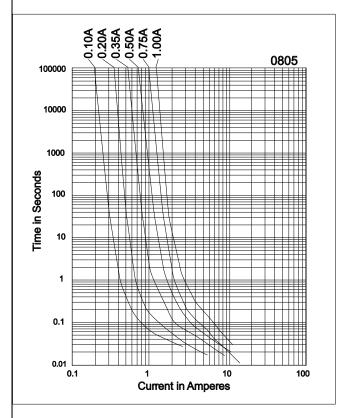
R<sub>typ</sub> = Typical resistance of device in initial (un-soldered) state.

R<sub>1max</sub> = Maximum resistance of device at 23°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

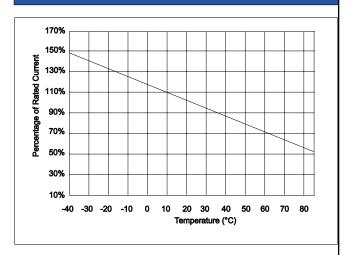


Temperature Reratin	Temperature Rerating								
	Ambient Operation Temperature								
	-40°C	-20°C	0°C	23°C	40°C	50°C	60°C	70°C	85°C
Part Number		Hold Current (A)							
0805P010	0.14	0.12	0.11	0.10	0.08	0.07	0.06	0.05	0.03
0805P020	0.28	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
0805P035	0.47	0.44	0.39	0.35	0.30	0.27	0.24	0.20	0.14
0805P050	0.68	0.62	0.55	0.50	0.40	0.37	0.33	0.29	0.23
0805P075	1.00	0.90	0.79	0.75	0.63	0.57	0.53	0.41	0.34
0805P100	1.35	1.25	1.10	1.00	0.82	0.74	0.65	0.55	0.42

#### Average Time Current Curves



#### Temperature Rerating Curve



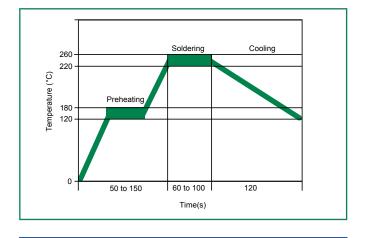
The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

# Soldering Parameters

Condition	Reflow		
Peak Temp/ DurationTime	260°C / 10 Sec		
Time above liquids (TAL) 220°C	60 Sec ~ 100 Sec		
Preheat 120°C~ 180°C	50 Sec ~ 150 Sec		
Storage Condition	0°C~35°C, ≦70%RH		

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N<sub>2</sub> environment for lead–free
- Recommended maximum paste thickness is 0.25mm (0.010 inch)
- Devices can be cleaned using standard industry methods and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.



# **Physical Specifications**

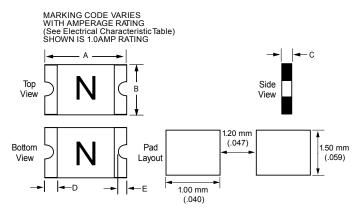
Terminal Material	Solder-Plated Copper (Solder Material: Matte Tin (Sn))			
Lead Solderability	Meets EIA Specification RS186-9E, ANSI/J-STD-002, Category 3			

## **Environmental Specifications**

Operating/Storage Temperature	-40°C to +85°C		
Maximum Device Surface Temperature in Tripped State	125°C		
Passive Aging	+85°C, 1000 hours -/+5% typical resistance change		
Humidity Aging	+85°C, 85%, R.H.,1000 hours -/+5% typical resistance change		
Thermal Shock	MIL-STD-202, Method 107G +85°C/-40°C 20 times -30% typical resistance change		
Solvent Resistance	MIL-STD-202, Method 215 No change		
Vibration	MIL-STD-883C, Method 2007.1, Condition A No change		
Moisture Sensitivity Level	Level 1, J-STD-020C		



## Dimensions



	А	В	С	D	Е
Type Number	mm	mm	mm	mm	mm
	Max	Max	Max	Min	typ
SMD0805P010TF	2.2	1.5	1.0	0.55	0.45
SMD0805P020TF	2.2	1.5	1.0	0.55	0.45
SMD0805P035TF	2.2	1.5	0.75	0.55	0.45
SMD0805P050TF	2.2	1.5	1.25	0.55	0.45
SMD0805P075TF	2.2	1.5	1.25	0.55	0.45
SMD0805P100TF	2.2	1.5	1.80	0.55	0.45

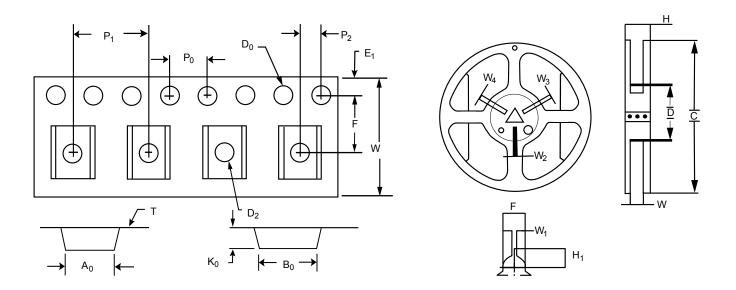
## Tape and Reel Specifications

TAPE SPECIFICATIONS: EIA-481-1 (mm)							
	0805L010 0805L020 0805L035	0805L050	0805L075	0805L100			
W	8.0+/-0.10	8.0+/-0.10	8.0+/-0.10	8.0+/-0.10			
F	3.5+/-0.05	3.5+/-0.05	3.5+/-0.05	3.5+/-0.05			
E <sub>1</sub>	1.75+/-0.10	1.75+/-0.10	1.75+/-0.10	1.75+/-0.10			
D <sub>0</sub>	1.55+/-0.05	1.55+/-0.05	1.55+/-0.05	1.55+/-0.05			
D <sub>1</sub>	1.0 (min)	1.0 (min)	1.0 (min)	1.0 (min)			
P <sub>0</sub>	4.0+/-0.10	4.0+/-0.10	4.0+/-0.10	4.0+/-0.10			
P <sub>1</sub>	4.0+/-0.10	4.0+/-0.10	4.0+/-0.10	4.0+/-0.10			
P <sub>2</sub>	2.0+/-0.05	2.0+/-0.05	2.0+/-0.05	2.0+/-0.05			
$A_0$	1.45+/-0.10	1.42+/-0.10	1.65+/-0.10	1.65+/-0.10			
B <sub>0</sub>	2.30+/-0.10	2.24+/-0.10	2.35+/-0.10	2.35+/-0.10			
Т	0.25+/-0.10	0.20+/-0.10	0.20+/-0.10	0.25+/-0.10			
K <sub>0</sub>	0.9+/-0.10	1.04+/-0.10	1.05+/-0.10	1.50+/-0.10			
Leader min.	390	390	390	390			
Trailer min.	160	160	160	160			

REEL DIMENSIONS: EIA-481-1 (mm)				
Н	12.0+/-0.05			
W	9.0+/-0.5			
D	Ø60+0.5			
F	Ø13.0+/-0.2			
С	Ø178+/- 1.0			
H <sub>1</sub>	11+/-0.5			
W <sub>1</sub>	2.2+/-0.5			
W <sub>2</sub>	3.0+0.5			
W <sub>3</sub>	4.0+0.5			
W <sub>4</sub>	5.5+0.5			



### Tape and Reel Specifications



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